

210 is capable of initiating a haptic effect independent of other haptic cells 210 in touch panel 206. In another embodiment, each of haptic cells 210 of touch panel 206 is capable of generating a unique haptic effect in response to a specific input. A unique haptic effect initiates a specific haptic sensation to a user's input. It should be noted that each cell 210 can be further divided into multiple sub cells wherein each sub cell can generate its own haptic effect.

[0031] FIG. 3(a) illustrates a haptic cell 210 using piezoelectric materials to generate haptic effects in accordance with one embodiment of the present invention. Cell 210 includes an electrical insulated layer 302, a piezoelectric material 304, and wires 306. Electrical insulated layer 302 has a top surface and a bottom surface, wherein the top surface is configured to receive inputs. A grid or an array of piezoelectric materials 304, in one embodiment, is constructed to form a piezoelectric or haptic layer, which also has a top and a bottom surface. The top surface of the piezoelectric layer is situated adjacent to the bottom surface of electrical insulated layer 302. Each cell 210 includes at least one piezoelectric material 304 wherein piezoelectric material 304 is used to generate haptic effects independent of other piezoelectric cells 210 in piezoelectric layer. In one embodiment, multiple adjacent or neighboring cells 210 are capable of generating multiple haptic effects in response to multiple substantially simultaneous touches. In another embodiment, each of cells 210 has a unique piezoelectric material thereby it is capable of initiating a unique haptic sensation.

[0032] It should be noted that a tactile touch panel, which includes an electrical insulated layer 302 and a piezoelectric layer, in some embodiments further includes a display. This display may be coupled to the bottom surface of the piezoelectric layer and is capable of projecting images that are viewable from the top surface of electrical insulated layer 302. It should be noted that the display can be a flat panel display or a flexible display. Piezoelectric materials 304, in one embodiment, are substantially transparent and small. The dimension of a cell 210 having piezoelectric material can be configured to be less than 5 millimeters by 5 millimeters. The shape of piezoelectric material 304, for example, deforms in response to electrical potentials applied via electrical wires 306.

[0033] During a manufacturing process, a piezoelectric film is printed to include an array or a grid of piezoelectric cells 210. In one embodiment, a film of cells 210 containing piezoelectric materials is printed on a sheet in a cell grid arrangement. The film further includes wirings for directly addressing every cell 210 in the device using electrical control signals. Cells 210, for example, can be stimulated using edge or back mounted electronics. Piezoelectric materials may include crystals and/or ceramics such as quartz (SiO₂)

[0034] FIG. 3(b) illustrates a haptic cell 210 generating haptic effects in accordance with an embodiment of the present invention. During operation, when a voltage potential applies to piezoelectric material 305 via wires 306, piezoelectric material 305 deforms from its original shape of piezoelectric material 304, as shown in FIG. 3(a), to expanded shape of piezoelectric material 305. Deformation of piezoelectric material 305 causes electrical insulated layer 303 to deform or strain from its original state of layer 302, as shown in FIG. 3(a). In an alternative embodiment, piezoelectric materials 305 return to its original state as soon as the voltage potential is removed. It should be noted that the underlying concept of the present invention does not change if additional

blocks (circuits or mechanical devices) are added to the device illustrated in FIG. 3(a-b). If the piezoelectric material is replaced with other materials such as shape memory alloys ("SMAs"), such material may be capable of maintaining its deformed shape for a period of time after the voltage potential is removed. It should be noted that the underlying concept of the embodiments of the present invention does not change if different materials other than piezoelectric actuators are employed.

[0035] FIG. 4(a) is a diagram 400 illustrating another embodiment of a haptic cell 210 using Micro-Electro-Mechanical Systems ("MEMS") device 402 to generate haptic effects in accordance with one embodiment of the present invention. Diagram 400 depicts a block 410, which shows a top view of cell 210. Cell 210 includes a MEMS device 402. In one embodiment, MEMS device 402 is substantially transparent thereby the image projection from a display, not shown in FIG. 4(a), can be viewed through block 410. It should be noted that each of haptic cells 210 is coupled to at least one wire to facilitate and generate haptic effects.

[0036] MEMS can be considered as an integration of mechanical devices, sensors, and electronics on a silicon or organic semiconductor substrate, which can be manufactured through conventional microfabrication process. For example, the electronic devices may be manufactured using semiconductor fabrication process and micromechanical devices may be fabricated using compatible microfabrication process. In one embodiment, a grid or an array of MEMS devices 402 are made of multiple cantilever-springs. A grid of cantilever-springs can be etched using MEMS manufacturing techniques. Also, electrical wirings for stimulating or driving cantilever-springs can also be directly etched onto the surface of the MEMS device 402 thereby every single MEMS device can be correctly addressed. MEMS cantilevers can be stimulated using a resonant drive (for vibrotactile) or direct actuation (kinesthetic). In another embodiment, the MEMS are stimulated in response to the energy generated by the display. For example, radio frequency energy, light, or heat generated by the pixels of a plasma display could provide an excitation source or activation signal for a MEMS haptic cell.

[0037] FIG. 4(b) illustrates a side view of MEMS device 402, wherein MEMS device 412 can be stimulated or deformed from its original state of MEMS device 402 to deformed state of MEMS device 414 when a voltage potential across MEMS device is applied. Displacement 404 between the original state and the deformed state depends on the composition of materials used and the size of MEMS device 402. Although smaller MEMS devices 402 are easier to fabricate, they offer smaller displacement 404. In one embodiment, cantilever-springs can be made of piezo materials. It should be noted that the actuation of piezo material is generally vibrotactile sensation. It should be further noted that piezo material can be used as a sensor for sensing fingertip positions and depressions.

[0038] MEMS device 402, in another embodiment, uses shape memory alloy ("SMA") in place of cantilever-spring as mentioned above. The actuation generated by MEMS device 402 using SMA provides kinesthetic actuation. SMA, also known as memory metal, could be made of copper-zinc-aluminum, copper-aluminum-nickel, nickel-titanium alloys, or a combination of copper-zinc-aluminum, copper-aluminum-nickel, and/or nickel-titanium alloys. Upon deforming from SMA's original shape, SMA regains its original shape in accordance with an ambient temperature and/or surrounding